SPECIFICATIONS FOR NICHIA WHITE LED MODEL : NSPWR70CSS-K1

NICHIA CORPORATION

1.SPECIFICATIONS

(1) Absolute Maximum Ratings	
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1) Absolute Maximum Ratings			(Ta=25°C)
Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	IF	60	mA
Pulse Forward Current	IFP	180	mA
Allowable Reverse Current	Ir	85	mA
Power Dissipation	PD	210	mW
Operating Temperature	Topr	-30 ~ + 85	°C
Storage Temperature	Tstg	$-40 \sim +100$	°C
Dice Temperature	Tj	100	°C
Soldering Temperature	Tsld	265°C for 5sec.	

IFP Conditions : Pulse Width ≤ 10 msec. and Duty $\leq 1/10$

(2	(2) Initial Electrical/Optical Characteristics						(Ta=25°C)
	Item		Symbol	Condition	Тур.	Max.	Unit
	Forward Voltage		VF	IF=50[mA]	(3.1)	3.5	V
	Luminous Flux*	-	φv	IF=50[mA]	(20.0)	-	lm
	Chromoticity Coordinato**	X	-	IF=50[mA]	0.344	-	-
	Chromaticity Coordinate**		-	IF=50[mA]	0.355	-	-

* Luminous flux value is traceable to the CIE 127:2007-compliant national standards.

****** Please refer to CIE 1931 chromaticity diagram.

(3) Ranking					Γ)	°a=25°C)
	Item		Symbol	Condition	Min.	Max.	Unit
		Rank P9			21.4	25.5	
	Luminous Flux	Rank P8	φv	IF=50[mA]	18.0	21.4	lm
		Rank P7			15.1	18.0	

* Luminous Flux Measurement allowance is $\pm 10\%$.

Color Ranks

	Rank b4				
Х	0.307	0.304	0.330	0.330	
у	0.315	0.330	0.360	0.339	
				-	

	Rank c0				
х	0.330	0.330	0.361	0.356	
у	0.318	0.360	0.385	0.351	

(IF=50mA,Ta=	25°C)
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	Rank b6				
Х	0.311	0.307	0.330	0.330	
У	0.294	0.315	0.339	0.318	

* Color Coordinates Measurement allowance is ± 0.01 .

* Basically, a shipment shall consist of the LEDs of a combination of the above ranks. The percentage of each rank in the shipment shall be determined by Nichia.

2.INITIAL OPTICAL/ELECTRICAL CHARACTERISTICS

Please refer to "CHARACTERISTICS" on the following pages.

3.OUTLINE DIMENSIONS AND MATERIALS

Please refer to "OUTLINE DIMENSIONS" on the following page. Resin

Material as follows ;

Epoxy Resin (over Diffused + Phosphor) :

Leadframe Ag plating Copper Alloy :

4.PACKAGING

• The LEDs are packed in cardboard boxes after packaging in stick.

Please refer to "STICK DIMENSIONS" and "PACKING" on the following pages.

The label on the packing unit shows ; Part Number, Lot Number, Ranking, Quantity

- · In order to protect the LEDs from mechanical shock, we pack them in cardboard boxes for transportation.
- The LEDs may be damaged if the boxes are dropped or receive a strong impact against them,

so precautions must be taken to prevent any damage.

• The boxes are not water resistant and therefore must be kept away from water and moisture.

• When the LEDs are transported, we recommend that you use the same packing method as Nichia.

5.LOT NUMBER

The first six digits number shows lot number.

The lot number is composed of the following characters;

 $\bigcirc \bigcirc \times \times \times \times - \bigcirc \blacksquare$

O - Year (7 for 2007, 8 for 2008)

- □ Month (1 for Jan., 9 for Sep., A for Oct., B for Nov.)
- $\times \times \times \times$ Nichia's Product Number
 - \triangle Ranking by Color Coordinates
 - Ranking by Luminous Flux

6.RELIABILITY (1) TEST ITEMS AND RESULTS

	Standard			Number of
Test Item	Test Method	Test Conditions	Note	Damaged
Resistance to	JEITA ED-4701	Tsld= $260 \pm 5^{\circ}$ C, 5sec.	1 time	0/22
Soldering Heat	300 302	1.6mm from the base of the stopper		
		(Pre treatment 30°C,70%,168hrs.)		
Solderability	JEITA ED-4701	Tsld= $235 \pm 5^{\circ}$ C, 5sec.	1 time	0/22
	300 303	(using flux)	over 95%	
Temperature Cycle	JEITA ED-4701	$-40^{\circ}\mathrm{C}\sim25^{\circ}\mathrm{C}\sim100^{\circ}\mathrm{C}\sim25^{\circ}\mathrm{C}$	100 cycles	0/50
	100 105	30min. 5min. 30min. 5min.		
Moisture Resistance Cyclic	JEITA ED-4701	$25^{\circ}C \sim 65^{\circ}C \sim -10^{\circ}C$	10 cycles	0/50
	200 203	90%RH 24hrs./1cycle		
Terminal Strength	JEITA ED-4701	Load 5N (0.5kgf)	No noticeable	0/50
(bending test)	400 401	$0^{\circ} \sim 90^{\circ} \sim 0^{\circ}$ bend 2 times	damage	
Terminal Strength	JEITA ED-4701	Load 10N (1kgf)	No noticeable	0/50
(pull test)	400 401	10 ± 1 sec.	damage	
High Temperature Storage	JEITA ED-4701	Ta=100°C	1000hrs.	0/50
	200 201			
Temperature Humidity	JEITA ED-4701	Ta=60°C, RH=90%	1000hrs.	0/50
Storage	100 103			
Low Temperature Storage	JEITA ED-4701	Ta=-40°C	1000hrs.	0/50
	200 202			
Steady State Operating Life		Ta=25°C, IF=60mA	1000 hrs.	0/50
Steady State Operating Life		60°C, RH=90%, IF=30mA	500 hrs.	0/50
of High Humidity Heat			200 ms.	0,50
Steady State Operating Life		Ta=-30°C, IF=50mA	1000 hrs.	0/50
of Low Temperature				
Electrostatic Discharges	JEITA ED-4701	R=1.5kΩ, C=100pF	3 times	0/22
	300 304	Test Voltage=2kV	Negative/Positive	

(2) CRITERIA FOR JUDGING DAMAGE

			Criteria for Judgement	
Item	Symbol	Test Conditions	Min.	Max.
Forward Voltage	VF	IF=50mA	-	U.S.L.*)× 1.1
Luminous Flux	φv	IF=50mA	L.S.L.**) \times 0.7	-

*) U.S.L.: Upper Standard Level

**) L.S.L.: Lower Standard Level

7.CAUTIONS

The LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of the LEDs is changed a little by an operating current. Care should be taken after due consideration when using LEDs.

(1) Storage

· Storage Conditions

Before opening the package :

The LEDs should be kept at 30°C or less and 90%RH or less. The LEDs should be used within a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.

After opening the package :

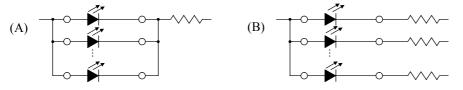
The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

• If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : more than 24 hours at 85°C

- Nichia LED leadframes are silver plated copper alloy. The silver surface may be affected by environments which contain corrosive substances. Please avoid conditions which may cause the LED to corrode, tarnish or discolor. This corrosion or discoloration may cause difficulty during soldering operations. It is recommended that the LEDs be used as soon as possible.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.
- (2) Recommended circuit

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LEDs with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage (VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product, such operation can cause migration resulting in LED damage.

(3) Static Electricity

 \cdot Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

- \cdot All devices, equipment and machinery must be properly grounded. It is recommended that precautions be taken against surge voltage to the equipment that mounts the LEDs.
- When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (below 1mA is recommended).
- Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current.

Criteria : (VF > 2.0V at IF=0.5mA)

(4) Soldering Conditions

- Nichia LEDs uses a copper alloy lead frame which provides a high thermal conductivity. Thermal stress such as soldering heat may reduce the reliability of the product; particular caution should be used to avoid damage prior to and during soldering. The recommended soldering conditions are listed in the following table.
- \cdot Solder the LED no closer than 1.6mm from the base of the stopper.
- The mechanical stress by clinching will cause degradation of the reliability on the LEDs. It is important to minimize the mechanical stress on the LEDs. It should be confirmed beforehand that it will not cause any problem when using it.
- · Recommended soldering conditions

Dip Soldering		Hand Soldering		
Pre-Heat	120°C Max.	Temperature	350°C Max.	
Pre-Heat Time	60 seconds Max.	Soldering Time	3 seconds Max.	
Solder Bath	260°C Max.	Position	No closer than 1.6 mm from the	
Temperature			base of the stopper.	
Dipping Time	5 seconds Max.			
Dipping Position	No lower than 1.6 mm from the			
	base of the stopper.			

- Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LEDs.
- · A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- \cdot Dip soldering should not be done more than one time.
- · Hand soldering should not be done more than one time.
- \cdot Do not apply any stress to the lead particularly when heated.
- · The LEDs must not be repositioned after soldering.
- \cdot After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused from warping of the PC board or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion but the User will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. Nichia's LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.
- \cdot When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.
- \cdot Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- (5) Cleaning
 - It is recommended that isopropyl alcohol be used as a solvent for cleaning the LEDs. When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.
 - Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be done to confirm whether any damage to the LEDs will occur.

(6) Heat Generation

- Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board, as well as other components. It is necessary to avoid intense heat generation and operate within the maximum ratings given in this specification.
- Please determine the operating current with consideration of the ambient temperature local to the LED and refer to the plot of Ambient temperature vs. Allowable Forward Current on CHARACTERISTICS in this specifications. Please also take measures to remove heat from the area near the LED to improve the operational characteristics of the LED.
- \cdot The equation ① indicates correlation between Tj and Ta, and the equation ② indicates correlation between Tj and Ts.

(7) Safety Guideline for Human Eyes

• The International Electrical Commission (IEC) published in 2006 IEC 62471:2006 Photobiological safety of lamps and lamp systems which includes LEDs within its scope. Meanwhile LEDs were removed from the scope of the IEC 60825-1:2007 laser safety standard, the 2001 edition of which included LED sources within its scope. However, keep in mind that some countries and regions have adopted standards based on the IEC laser safety standard IEC 60825-1:2001 which includes LEDs within its scope.

Following IEC 62471:2006, most of Nichia LEDs can be classified as belonging to either Exempt Group or Risk Group 1. Optical characteristics of a LED such as output power, spectrum and light distribution are factors that affect the risk group determination of the LED. Especially a high-power LED, that emits light containing blue wavelengths, may be in Risk Group 2.

Great care should be taken when viewing directly the LED driven at high current or the LED with optical instruments, which may greatly increase the hazard to your eyes.

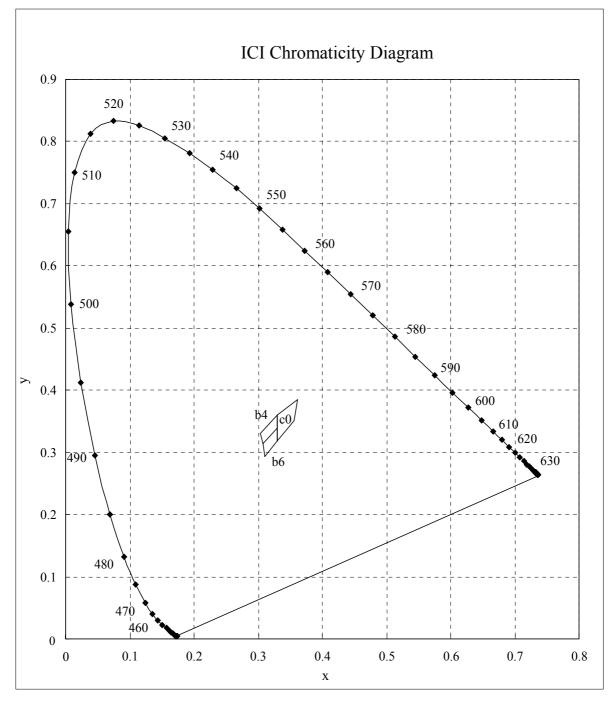
(8) Others

· NSPWR70CS-K1 complies with RoHS Directive.

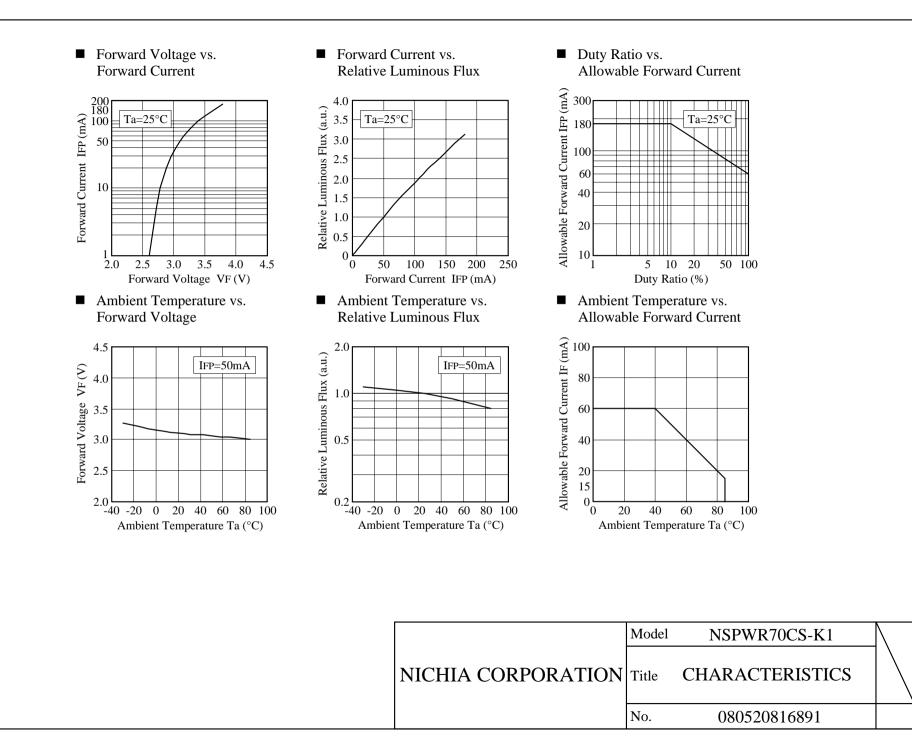
- Flashing lights have been known to cause discomfort in people; you can prevent this by taking precautions during use. Also, people should be cautious when using equipment that has had LEDs incorporated into it.
- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances). Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control systems, automobiles, traffic control equipment, life support systems and safety devices).
- User shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the User shall inform Nichia directly before disassembling or analysis.

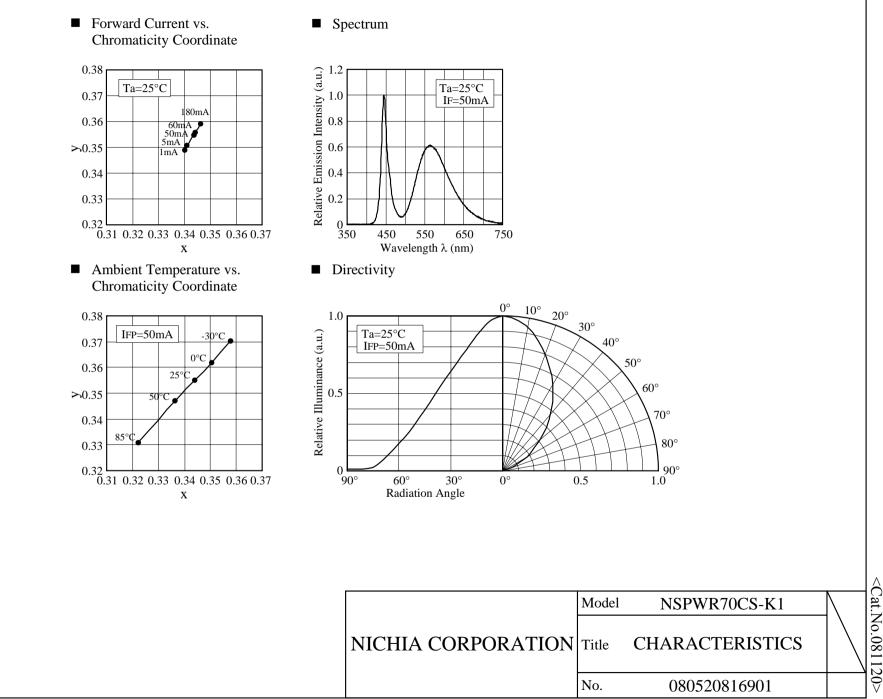
• The formal specifications must be exchanged and signed by both parties before large volume purchase begins.

• The appearance and specifications of the product may be modified for improvement without notice.

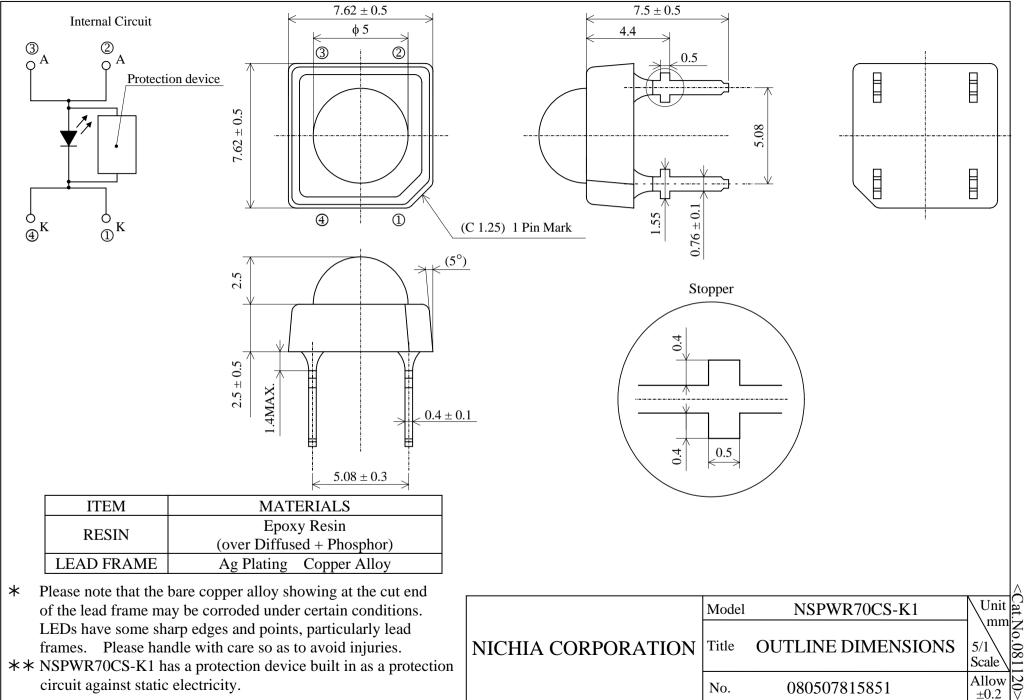


* Color Coordinates Measurement allowance is ± 0.01 .

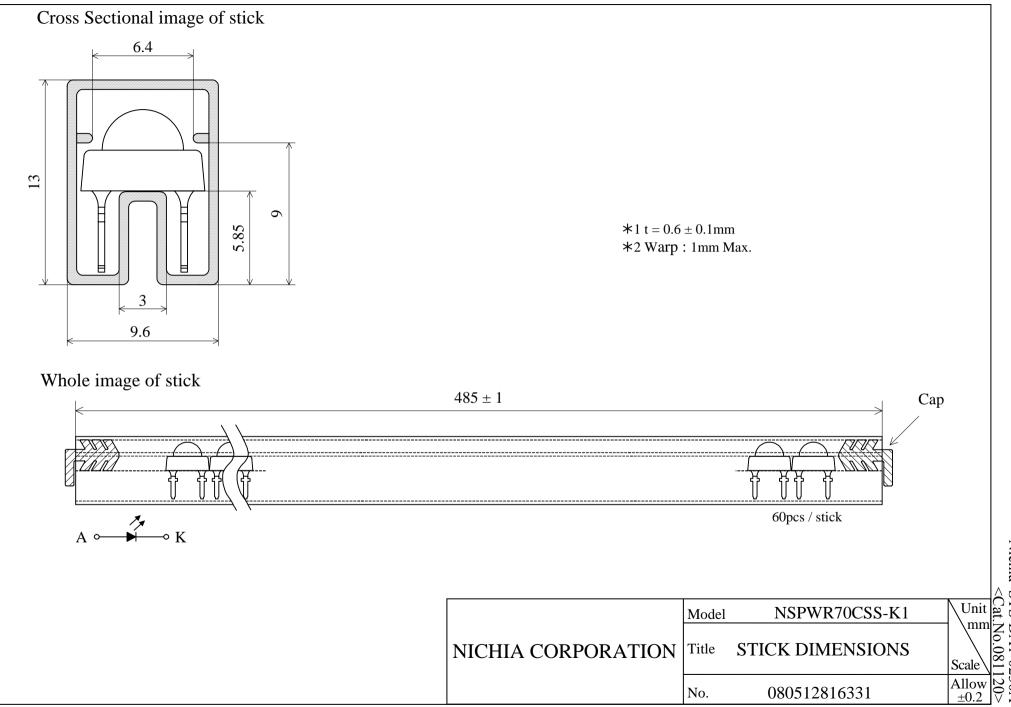




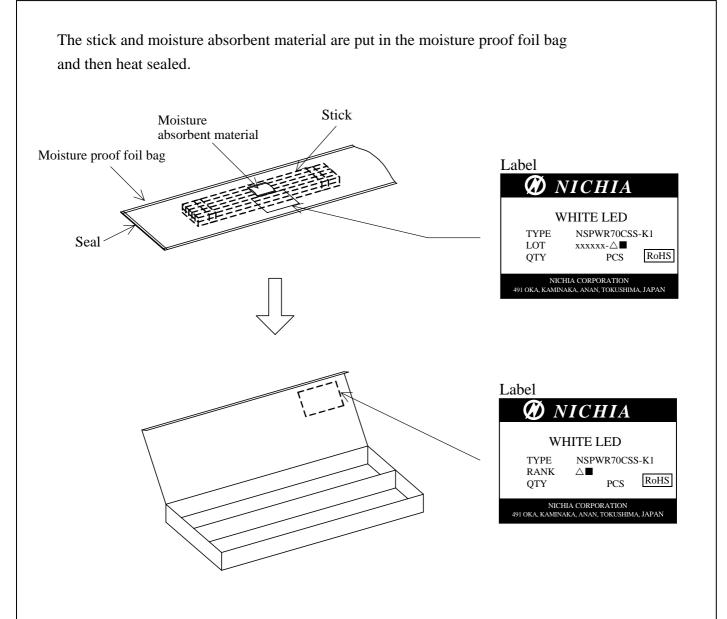
Nichia STS-DA1-0230A <Cat.No.081120>



Nichia STS-DA1-0230A



Nichia STS-DA1-0230A <<u>Cat.No.081120></u>



Packing unit

	Stick/bag	Quantity/bag (pcs)
Moisture proof foil bag	10 stick Max.	600 MAX.

Cardboard box	Dimensions (mm)	Stick/box	Quantity/box (pcs)
Cardboard box M	$590 \times 277 \times 120 \times 4t$	100 stick MAX.	6,000 MAX.
Cardboard box 1/2L	613×298×268×7t	200 stick MAX.	12,000 MAX.
Cardboard box L	613×298×518×7t	400 stick MAX.	24,000 MAX.

	Model	NSPWR70CSS-K1	Ν
NICHIA CORPORATION	Title	PACKING	
	No.	080512816351	